

QT-Brightek Optocoupler Series

4-PIN DC Input Optocoupler

Part No.: QTM357

Product: QTM357	Date: April 13, 2018	Page 1 of 13
	Version# 1.1	



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Introduction

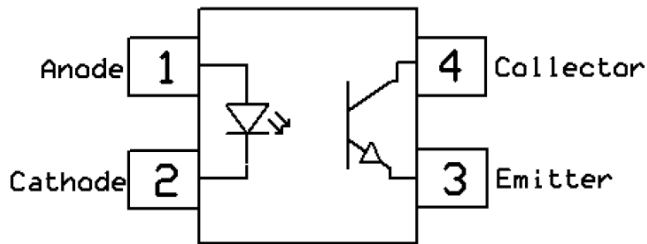
Feature:

- High Isolation voltage between input and output (Viso = 3750V rms)
- DC input with transistor output
- Operating Temperature up to 110 °C
- Mini-Flat package

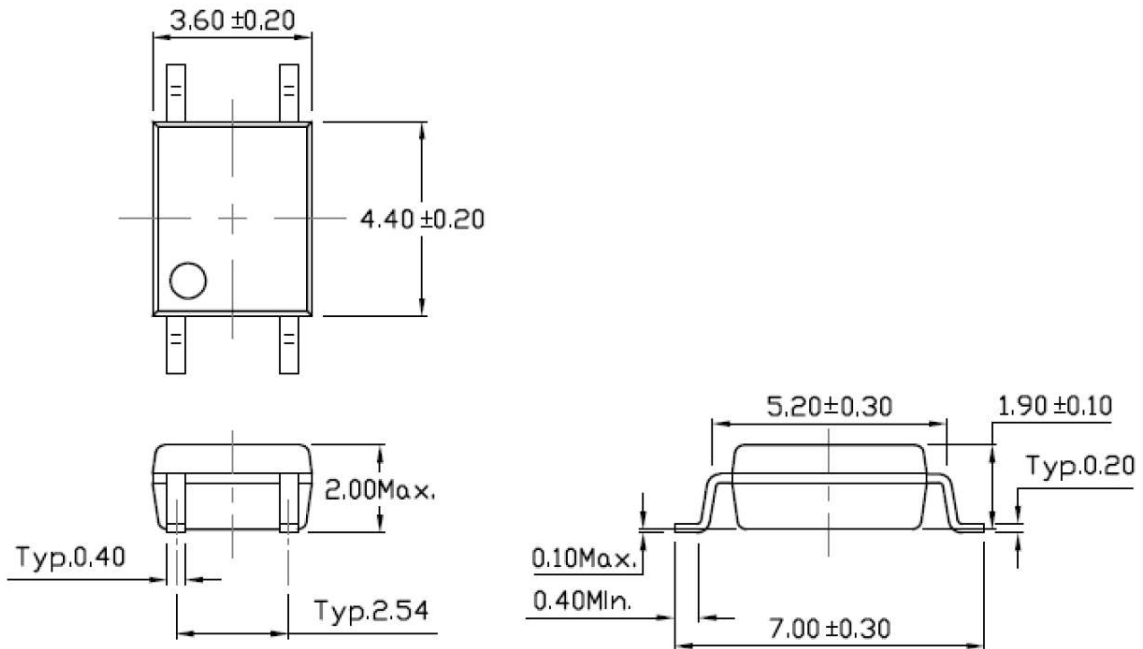
Certification & Compliance:

- Pb free and RoHS Compliant
- UL recognized (File #E338132)
- cUL recognized (File #E338132)
- VDE (Pending Approval)

Schematic:



Dimension: (Dot location indicates pin 1)



All Dimensions are in mm

Absolute Maximum Rating

Symbol	Parameter	Rating	Units
V _{ISO}	Isolation Voltage	3750	V _{RMS}
T _{STG}	Storage Temperature	-55 ~ +150	°C
T _{OPR}	Operating Temperature	-55 ~ +110	°C
T _{SOL}	Lead Solder Temperature	260 for 10 sec	°C
P _{TOT}	Total Power Dissipation	200	mW
EMITTER			
I _F	Continuous Forward Current	50	mA
I _{FP}	Peak Forward Current (≤ 1us, 300pps)	1	A
V _R	Reverse Voltage	6	V
P _D	Power Dissipation	70	mW
	Power Dissipation Derated above 100°C	-	mW/°C
DETECTOR			
B _{VCEO}	Collector-Emitter Breakdown Voltage	80	V
B _{VECO}	Emitter-Collector Breakdown Voltage	6	V
I _C	Collector current	50	mA
P _C	Power Dissipation	150	mW

Electrical Characteristic (T_A=25 °C)

Emitter

Symbol	Characteristics	Device	Test Condition	Range			Unit
				Min	Typ	Max	
V _F	Forward Voltage	-	I _F =10mA	-	1.24	1.4	V
I _R	Reverse Current		V _R =6V	-	-	5	uA
C _{IN}	Input Capacitance		f =1kHz	-	10	250	pF

Detector

Symbol	Characteristic	Device	Test Condition	Range			Unit
				Min	Typ	Max	
B _{VCEO}	Collector-Emitter Breakdown Voltage	-	I _C =100uA	80	-	-	V
B _{VECO}	Emitter-Collector Breakdown Voltage	-	I _C =100uA	7	-	-	uA
I _{CEO}	Collector-Emitter Dark Current	-	V _{CE} =20V, I _F =0mA	-	-	100	nA

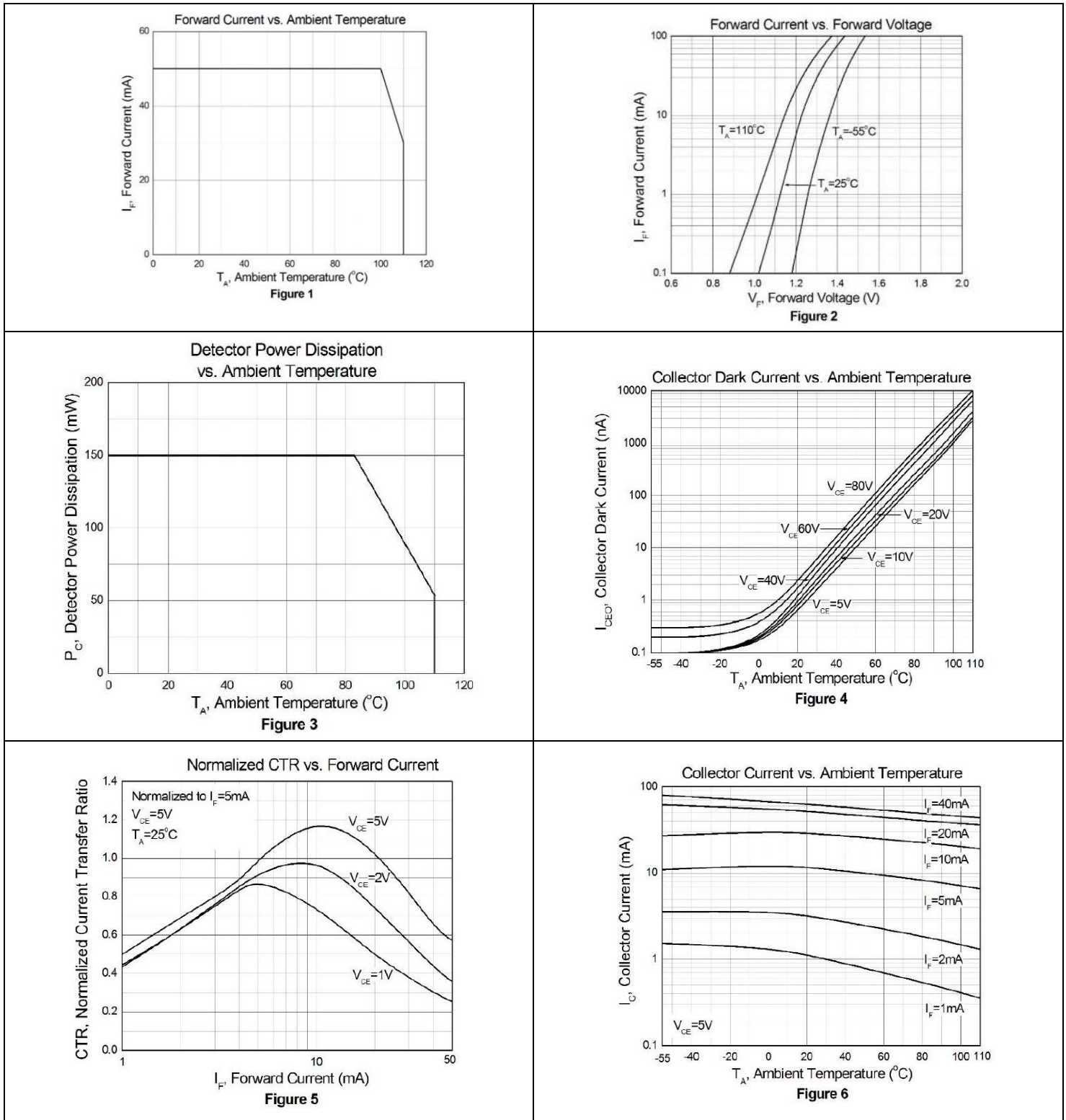
Transfer Characteristics (T_A=0 to 70°C unless specified otherwise)

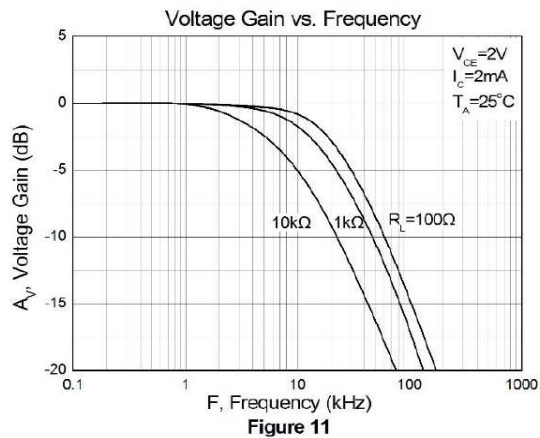
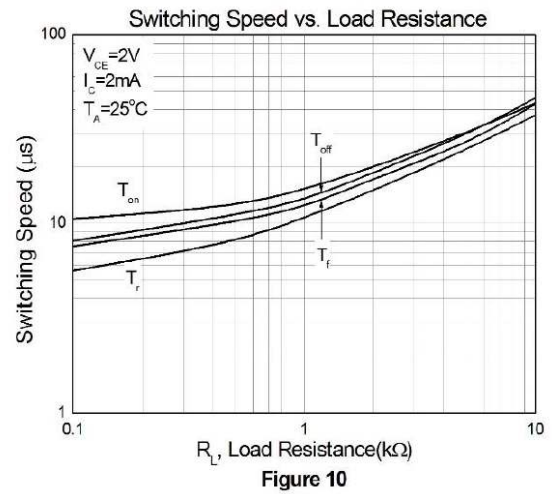
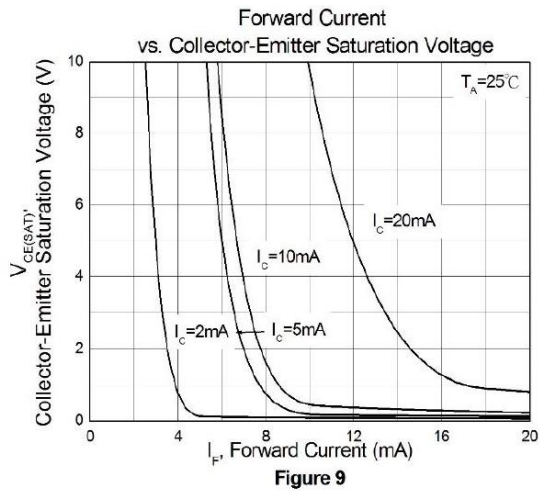
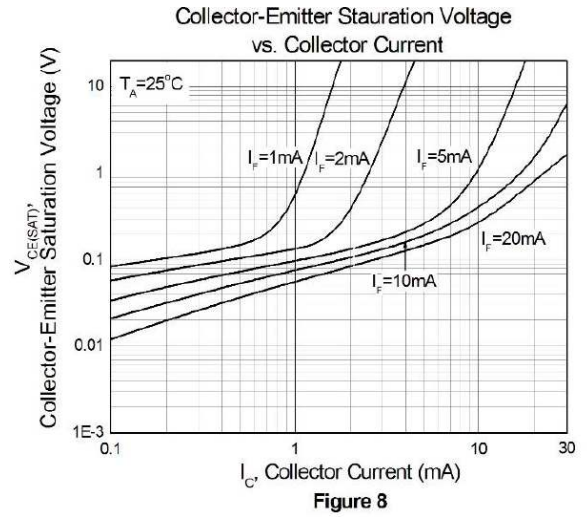
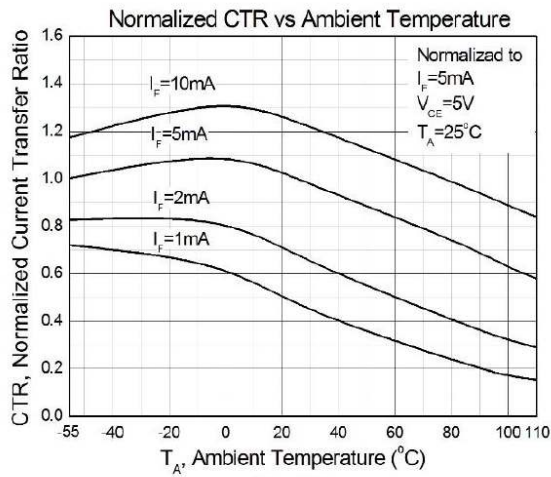
Symbol	Characteristic	Device	Test Condition	Range			Unit
				Min	Typ	Max	
CTR	Current Transfer Ratio	QTM357	I _F = 1mA, V _{CE} =5V	50	-	600	%
		QTM357A		80	-	160	
		QTM357B		130	-	260	
		QTM357C		200	-	400	
		QTM357D		300	-	600	
V _{CE(SAT)}	Collector-Emitter Saturation Voltage		I _F = 20mA, I _C =1mA	-	0.06	0.2	V
R _{IO}	Isolation Resistance		V _{IO} =500V _{DC}	5x10 ¹⁰	-	-	Ω
C _{IO}	Isolation Capacitance		f=1MHz	-	0.5	1.0	pF

Switching Characteristics (T_A=25°C, V_{CC}=5V)

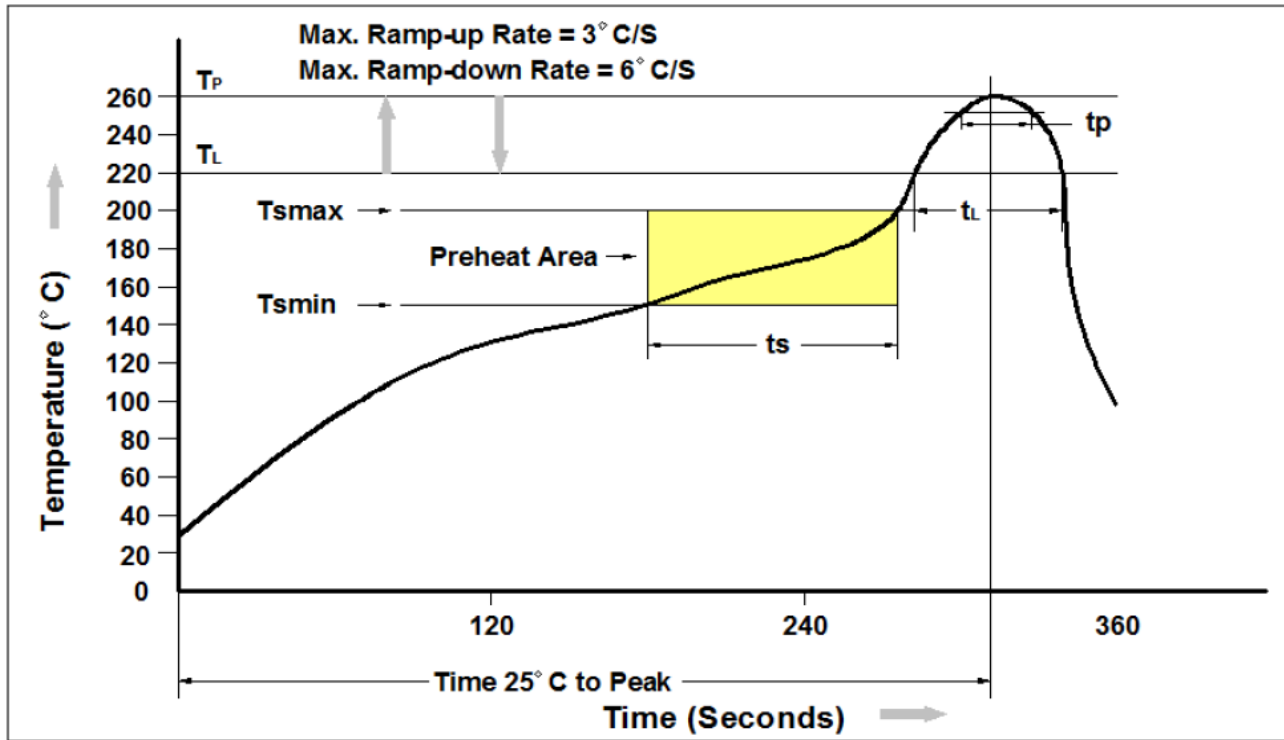
Symbol	Characteristic	Device	Test Condition	Range			Unit
				Min	Typ	Max	
t _r	Rise Time		I _C =2mA, V _{CE} 2V, R _L =100Ω	-	6	18	us
t _f	Fall Time			-	8	18	

Characteristic Curves

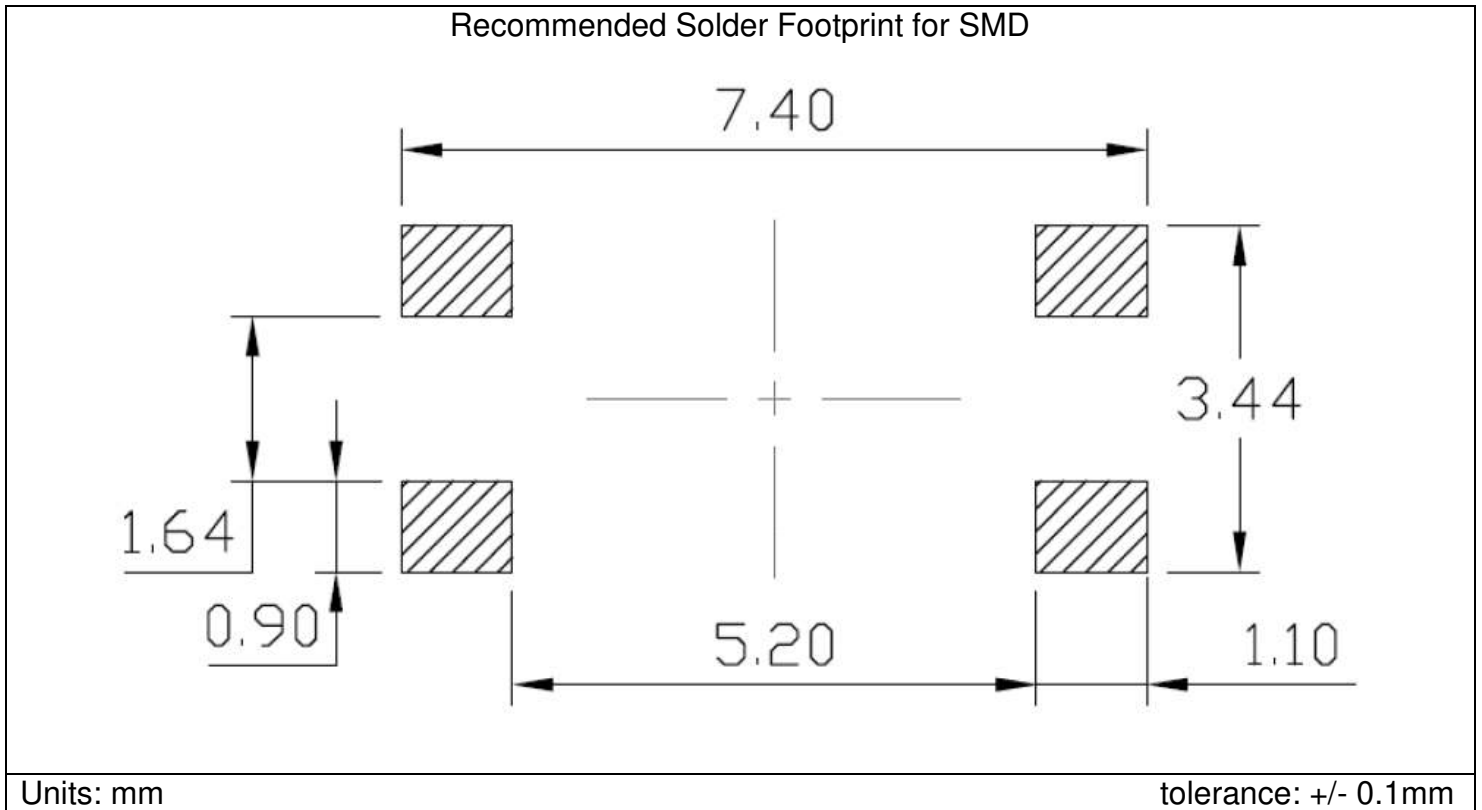


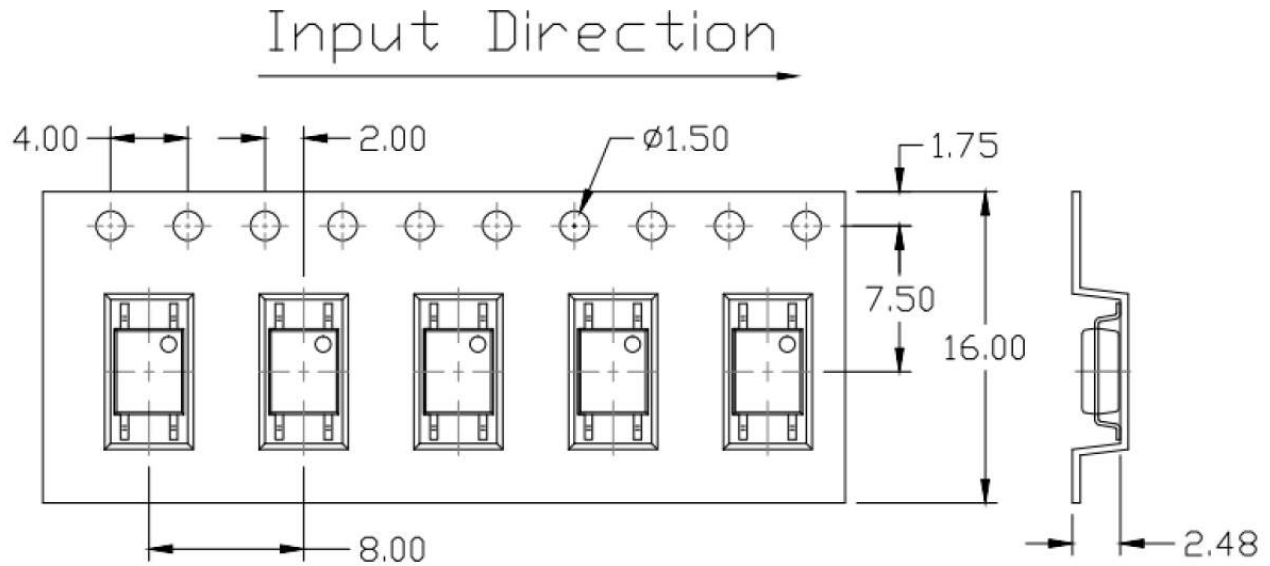
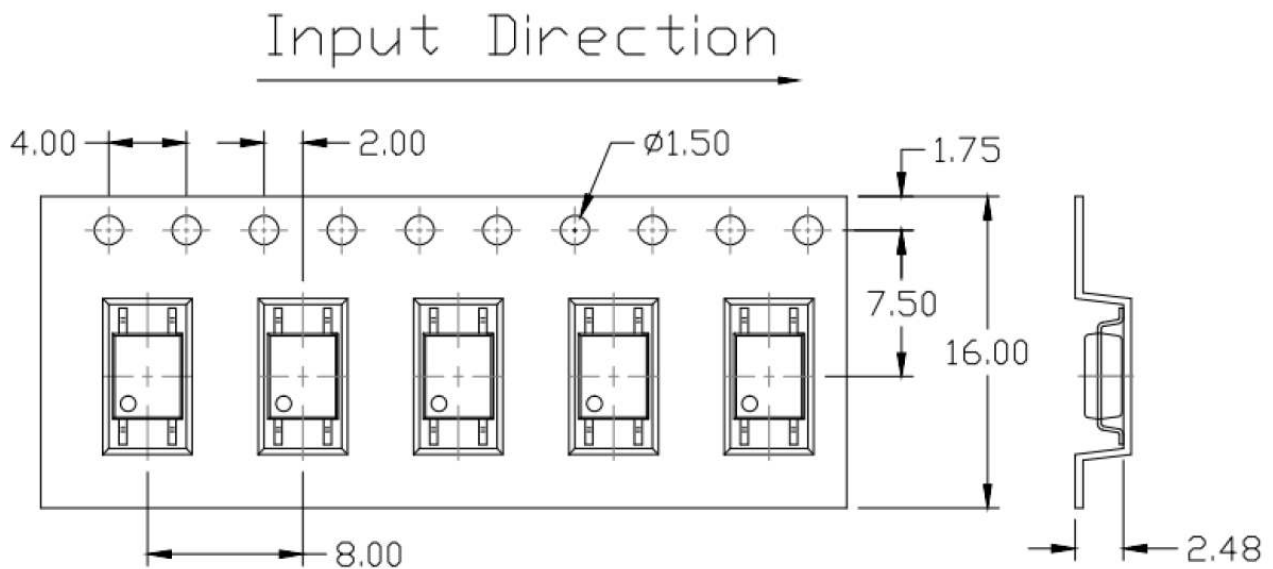


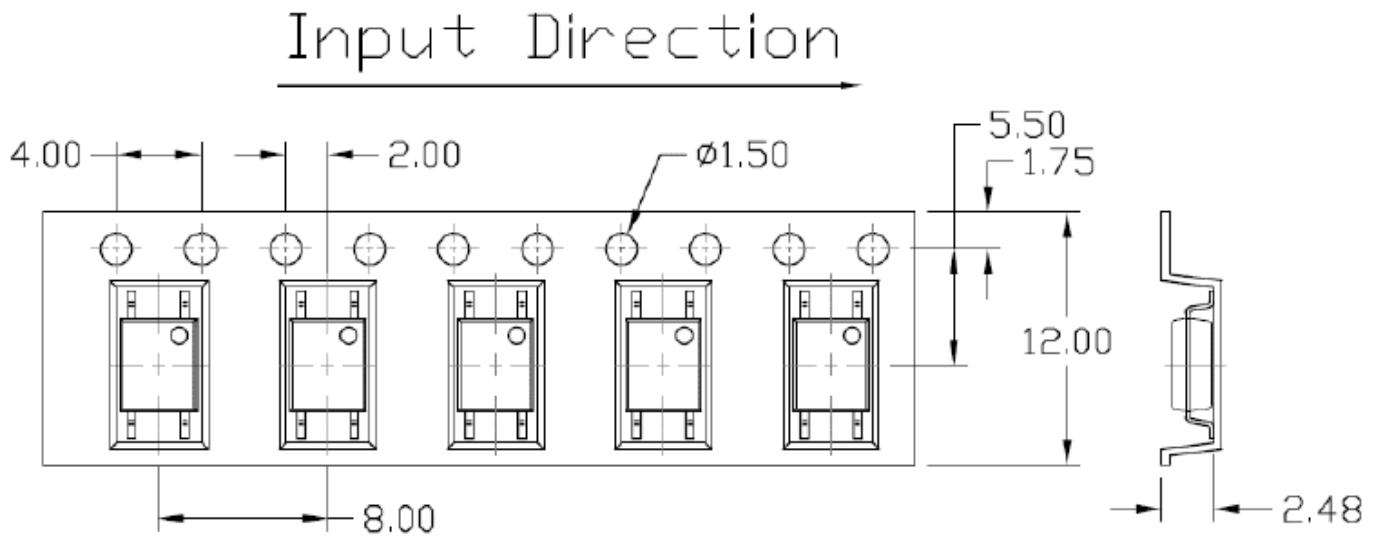
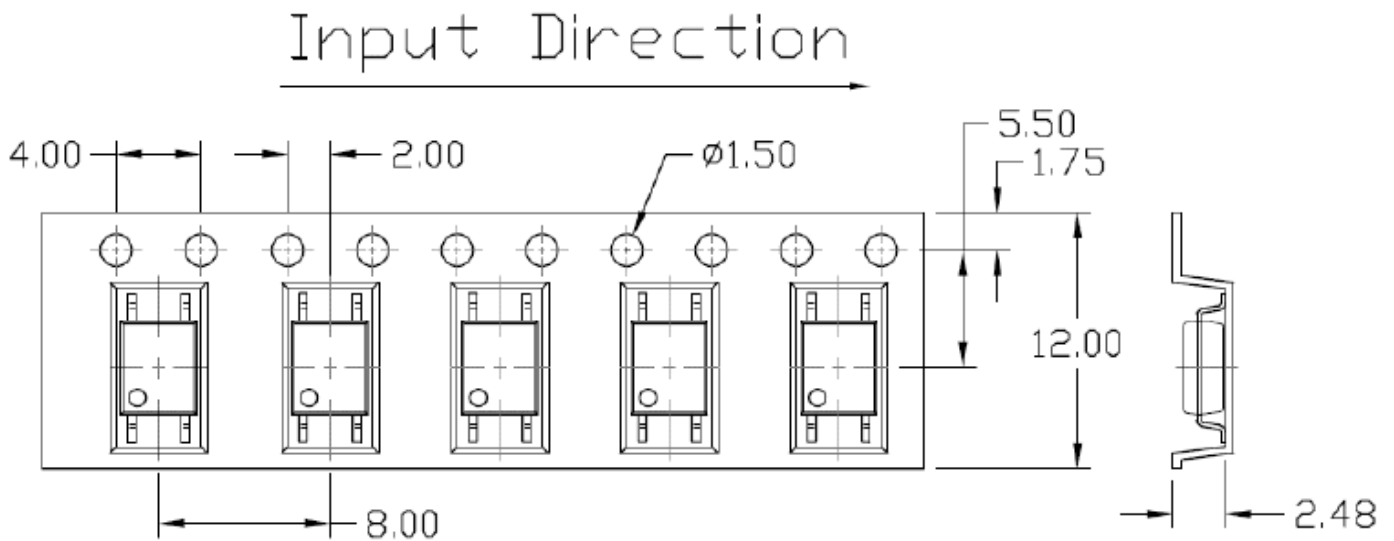
Solder Profile & Footprint



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	150°C
Temperature Max. (T _{smax})	200°C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



Packing & Labeling**Tape Dimension:****Option T1****Option T2**

Option T3**Option T4**

Device Marking

QT = QT-Brightek Corporation
 M= Mini-Flat Package
 357 = part number
 R= CTR Rank
 Y = Year
 WW = Week
 V = VDE Option
 K= Manufacturing code

Ordering Information

QTM357XVZ
 X = Part number (X=A,B,C,D or None)
 V = VDE option (V or None)
 Z = Tape and reel option (T1, T2, T3, T4)

Option	Description	Quantity
T1	Surface Mount Lead Forming – with Option 1 Taping	3000 pcs/ reel
T2	Surface Mount Lead Forming – with Option 2 Taping	3000 pcs/ reel
T3	Surface Mount Lead Forming – with Option 3 Taping	3000 pcs/ reel
T4	Surface Mount Lead Forming – with Option 4 Taping	3000 pcs/ reel



Revision History

Description:	Revision #	Revision Date
Initial release of QTM357	1.0	02/08/2018
Amend the Marking	1.1	04/13/2018

Disclaimer

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.